

C4D08120E–Silicon Carbide Schottky Diode

Z-REC™ RECTIFIER

V_{RRM}	= 1200 V
$I_F, T_C < 135^\circ\text{C}$	= 12 A
Q_c	= 49 nC

Features

- 1200-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Positive Temperature Coefficient on V_F

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Solar Inverters
- Power Factor Correction

Package



TO-252-2



Part Number	Package	Marking
C4D08120E	TO-252-2	C4D08120

Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V		
V_{RSM}	Surge Peak Reverse Voltage	1300	V		
V_{DC}	DC Blocking Voltage	1200	V		
I_F	Continuous Forward Current	12	A	$T_C = 135^\circ\text{C}$; No AC component	
I_{FRM}	Repetitive Peak Forward Surge Current	38 26	A	$T_C = 25^\circ\text{C}$, $t_p = 10$ ms, Half Sine pulse $T_C = 110^\circ\text{C}$, $t_p = 10$ ms, Half Sine pulse	
I_{FSM}	Non-Repetitive Peak Forward Surge Current	64 50	A	$T_C = 25^\circ\text{C}$, $t_p = 10$ ms, Half Sine pulse $T_C = 110^\circ\text{C}$, $t_p = 10$ ms, Half Sine pulse	
P_{tot}	Power Dissipation	136 59	W	$T_C = 25^\circ\text{C}$ $T_C = 110^\circ\text{C}$	
T_C	Maximum Case Temperature	135	$^\circ\text{C}$		
T_J	Operating Junction Range	-55 to +175	$^\circ\text{C}$		
T_{stg}	Storage Temperature Range	-55 to +135	$^\circ\text{C}$		

Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.5 2.2	1.8 3	V	$I_F = 2\text{ A}$ $T_J = 25^\circ\text{C}$ $I_F = 2\text{ A}$ $T_J = 175^\circ\text{C}$	
I_R	Reverse Current	35 100	250 350	μA	$V_R = 1200\text{ V}$ $T_J = 25^\circ\text{C}$ $V_R = 1200\text{ V}$ $T_J = 175^\circ\text{C}$	
Q_C	Total Capacitive Charge	49		nC	$V_R = 1200\text{ V}$, $I_F = 2\text{ A}$ $di/dt = 200\text{ A}/\mu\text{s}$ $T_J = 25^\circ\text{C}$	
C	Total Capacitance	560 37 27		pF	$V_R = 0\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 400\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 800\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$	

Note:

1. This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

Symbol	Parameter	Typ.	Unit
$R_{\theta JC}$	TO-252 Package Thermal Resistance from Junction to Case	1.1	$^\circ\text{C}/\text{W}$

Typical Performance

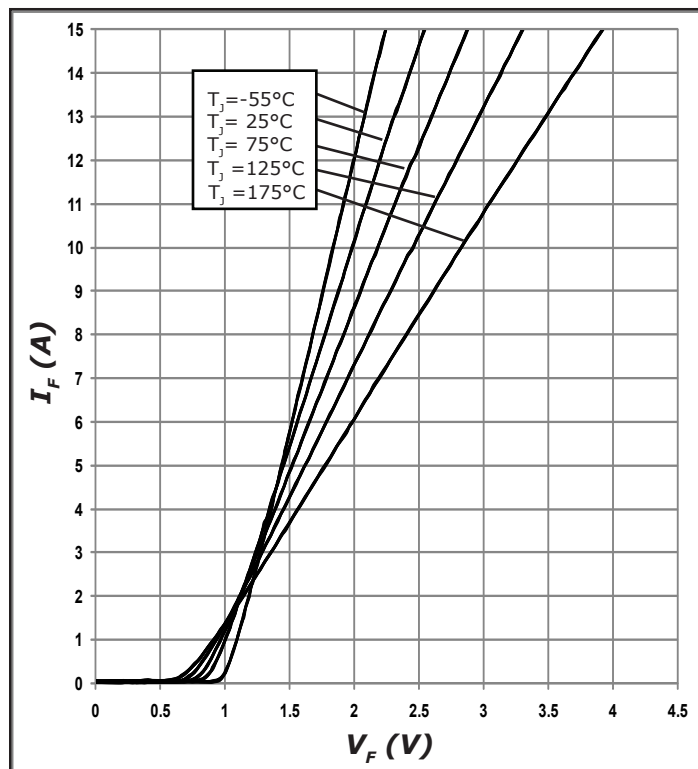


Figure 1. Forward Characteristics

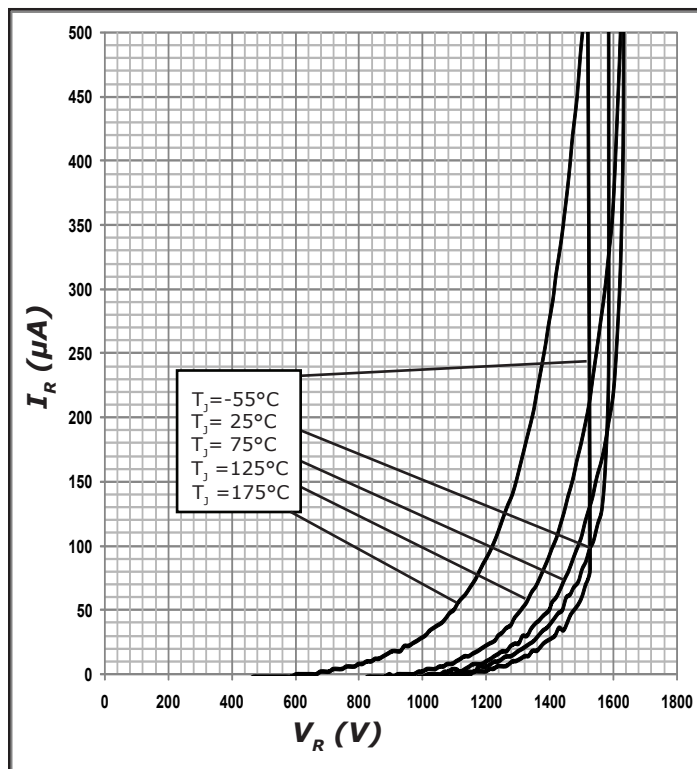


Figure 2. Reverse Characteristics

Typical Performance

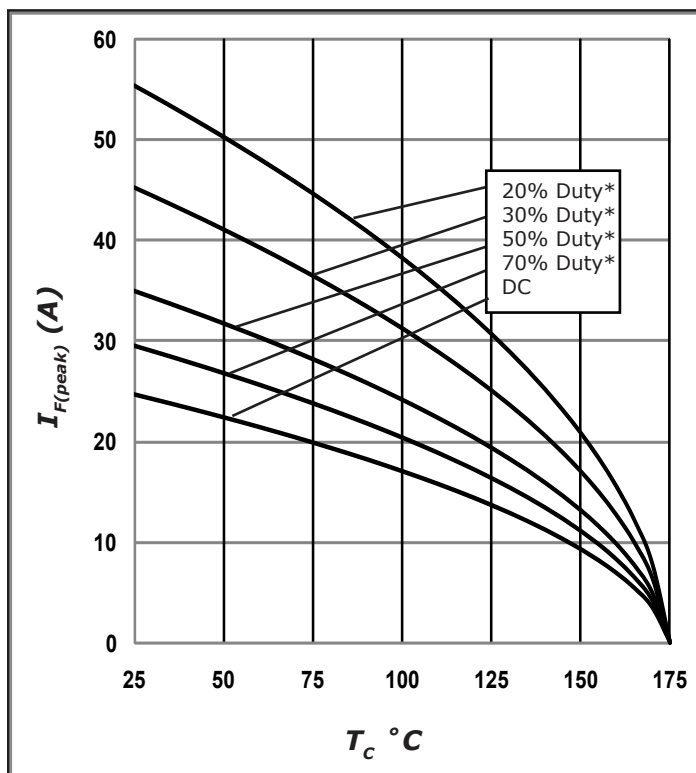


Figure 3. Current Derating

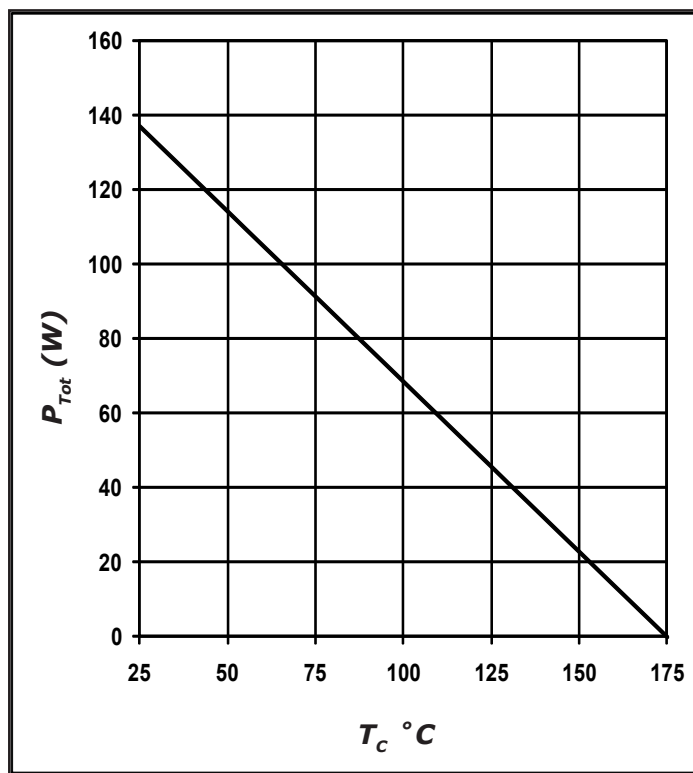


Figure 4. Power Derating

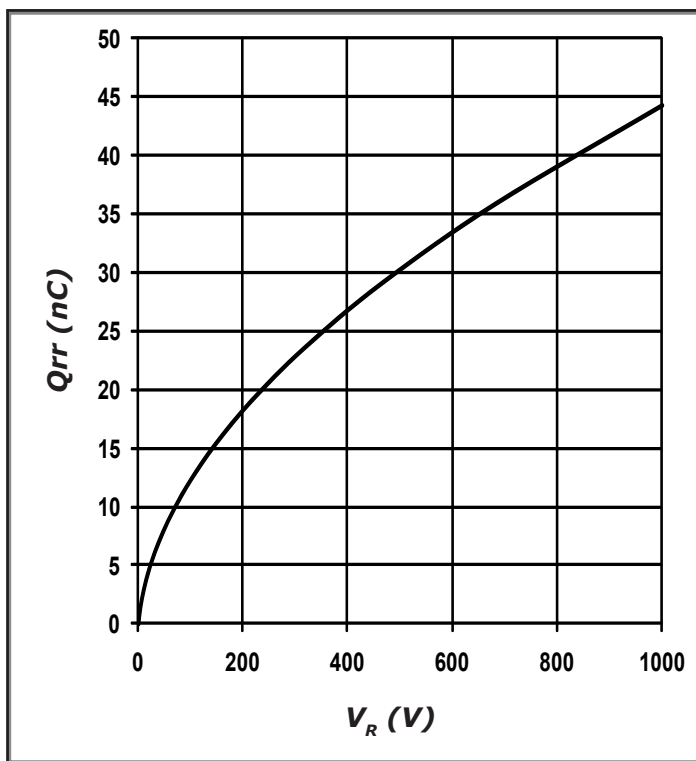


Figure 5. Recovery Charge vs. Reverse Voltage

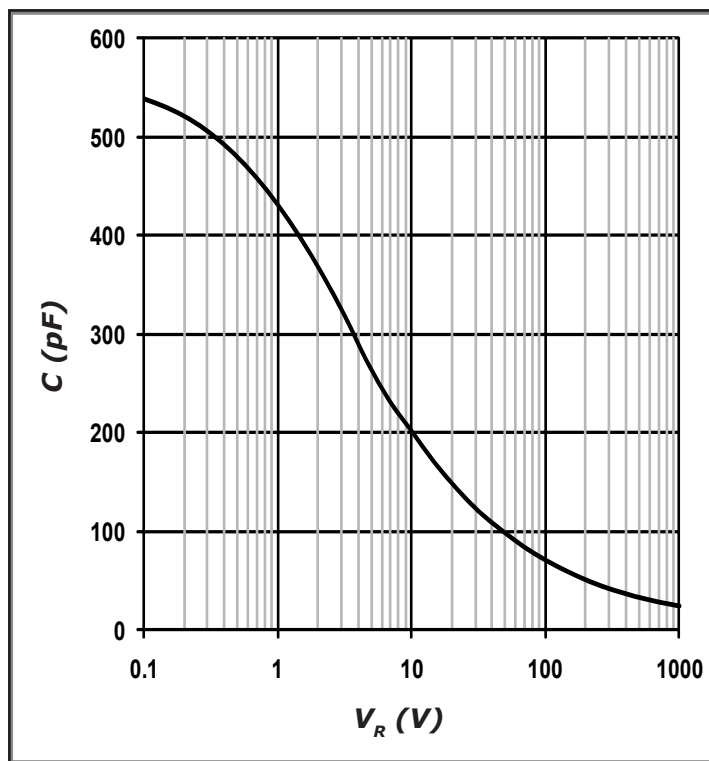


Figure 6. Capacitance vs. Reverse Voltage

Typical Performance

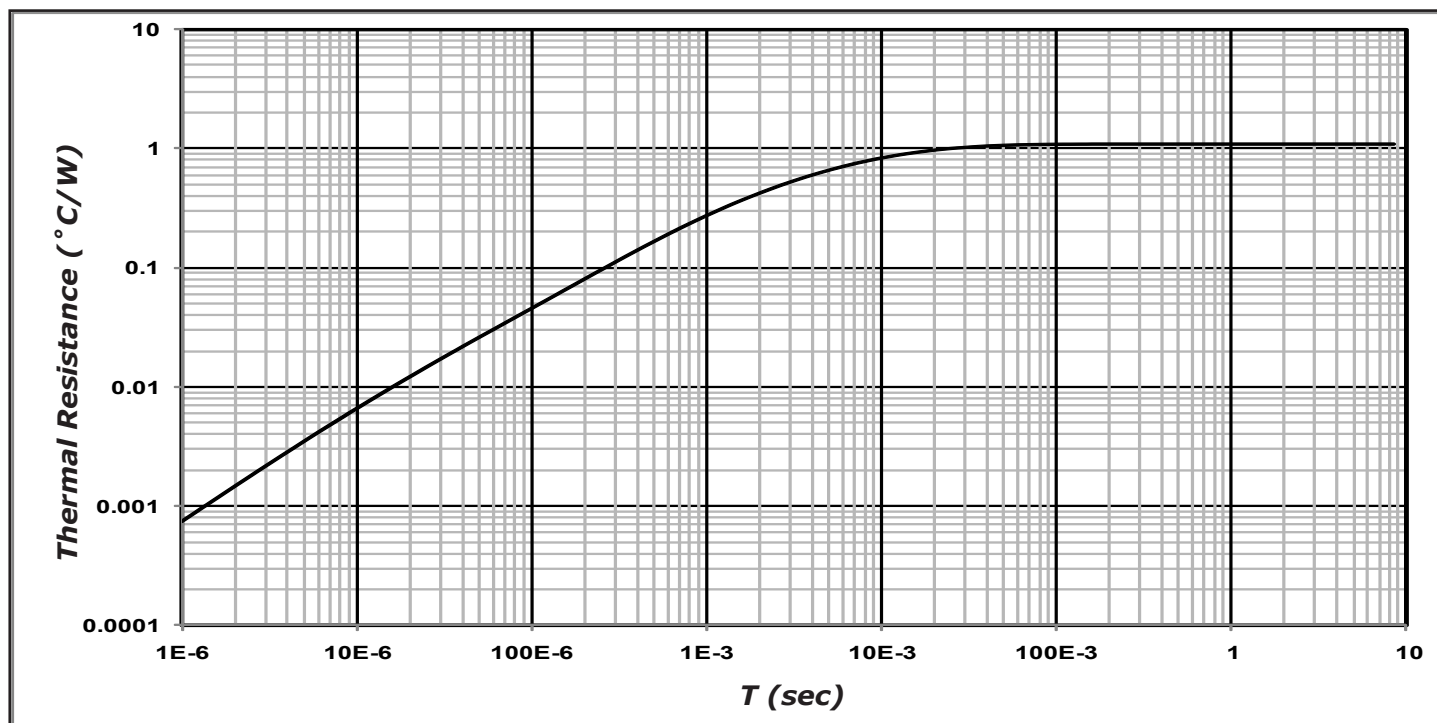
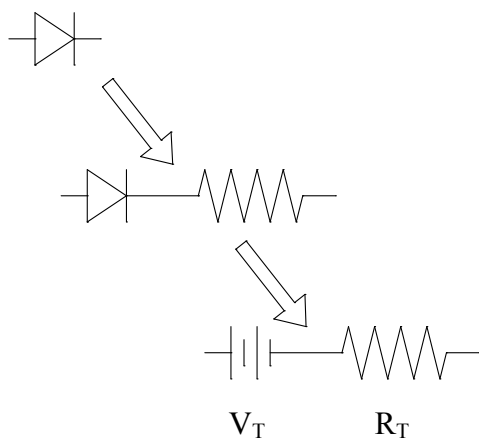


Figure 7. Transient Thermal Impedance

Diode Model



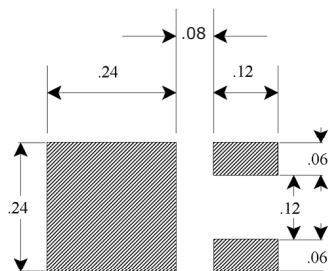
$$V_{fT} = V_T + I_f \cdot R_T$$

$$V_T = 0.96 + (T_j \cdot -2.1 \cdot 10^{-3})$$

$$R_T = 0.06 + (T_j \cdot 8.0 \cdot 10^{-4})$$

Note: T_j = Diode Junction Temperature In Degrees Celcius

Recommended Solder Pad Layout

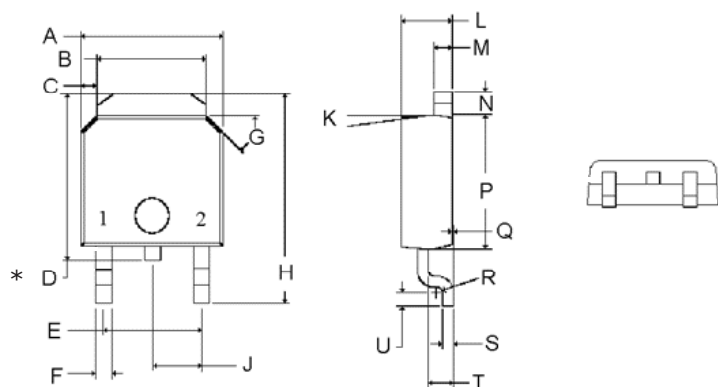


TO-252-2

Part Number	Package	Marking
C4D08120E	TO-252-2	C4D08120

Package Dimensions

Package TO-252-2



POS	Inches		Millimeters	
	Min	Max	Min	Max
A	.250	.289	6.350	7.341
B	.197	.215	5.004	5.461
C	.027	.050	.686	1.270
D*	.270	.322	6.858	8.179
E	.178	.182	4.521	4.623
F	.025	.045	.635	1.143
G	44°	46°	44°	46°
H	.380	.410	9.652	10.414
J	.090 TYP		2.286 TYP	
K	6°	8°	6°	8°
L	.086	.094	2.184	2.388
M	.018	.034	.457	.864
N	.035	.050	.889	1.270
P	.231	.246	5.867	6.248
Q	0.00	.005	0.00	.127
R	R0.010 TYP		R0.254 TYP	
S	.017	.023	.432	.584
T	.038	.045	.965	1.143
U	.021	.029	.533	.737

Note:

* Tab "D" may not be present

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